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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

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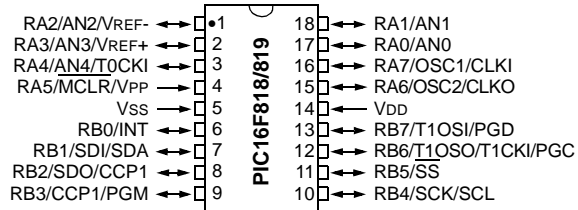
Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	10MHz
Connectivity	I ² C, SPI
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	16
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 5x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf819t-i-ml

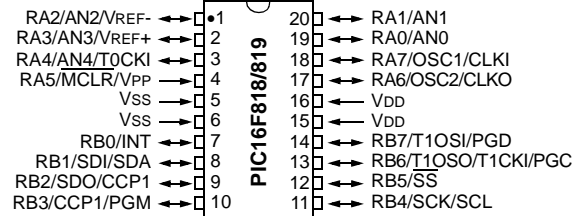
PIC16F818/819

Pin Diagrams

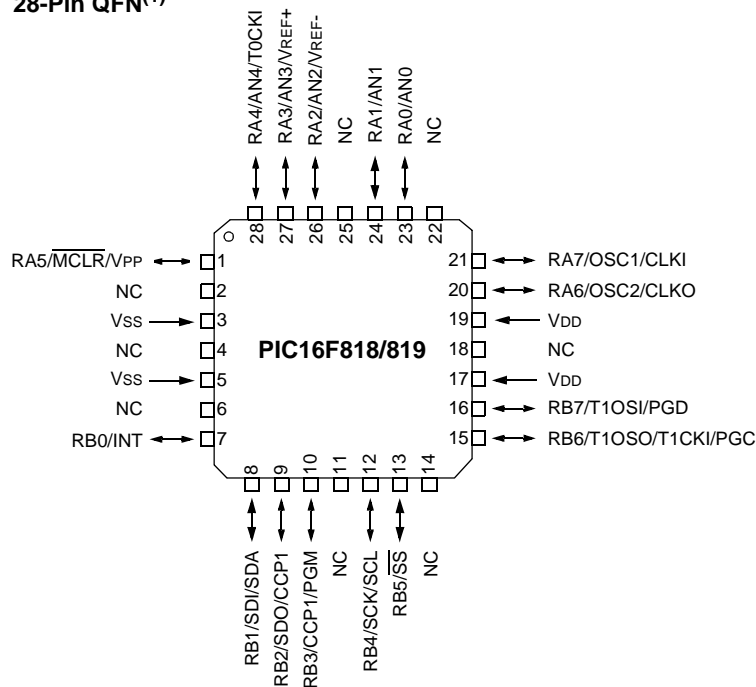
18-Pin PDIP, SOIC



20-Pin SSOP



28-Pin QFN⁽¹⁾



Note 1: For the QFN package, it is recommended that the bottom pad be connected to VSS.

2.2.2.6 PIE2 Register

The PIE2 register contains the individual enable bit for the EEPROM write operation interrupt.

REGISTER 2-6: PIE2: PERIPHERAL INTERRUPT ENABLE REGISTER 2 (ADDRESS 8Dh)

U-0	U-0	U-0	R/W-0	U-0	U-0	U-0	U-0
—	—	—	EEIE	—	—	—	—
bit 7							bit 0

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **EEIE:** EEPROM Write Operation Interrupt Enable bit

1 = Enable EE write interrupt

0 = Disable EE write interrupt

bit 3-0 **Unimplemented:** Read as '0'

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

2.2.2.7 PIR2 Register

The PIR2 register contains the flag bit for the EEPROM write operation interrupt.

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the Global Interrupt Enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 2-7: PIR2: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 2 (ADDRESS 0Dh)

U-0	U-0	U-0	R/W-0	U-0	U-0	U-0	U-0
—	—	—	EEIF	—	—	—	—
bit 7							bit 0

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **EEIF:** EEPROM Write Operation Interrupt Enable bit

1 = Enable EE write interrupt

0 = Disable EE write interrupt

bit 3-0 **Unimplemented:** Read as '0'

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

3.0 DATA EEPROM AND FLASH PROGRAM MEMORY

The data EEPROM and Flash program memory are readable and writable during normal operation (over the full VDD range). This memory is not directly mapped in the register file space. Instead, it is indirectly addressed through the Special Function Registers. There are six SFRs used to read and write this memory:

- EECON1
- EECON2
- EEDATA
- EEDATH
- EEADR
- EEADRH

This section focuses on reading and writing data EEPROM and Flash program memory during normal operation. Refer to the appropriate device programming specification document for serial programming information.

When interfacing the data memory block, EEDATA holds the 8-bit data for read/write and EEADR holds the address of the EEPROM location being accessed. These devices have 128 or 256 bytes of data EEPROM, with an address range from 00h to 0FFh. Addresses from 80h to FFh are unimplemented on the PIC16F818 device and will read 00h. When writing to unimplemented locations, the charge pump will be turned off.

When interfacing the program memory block, the EEDATA and EEDATH registers form a two-byte word that holds the 14-bit data for read/write and the EEADR and EEADRH registers form a two-byte word that holds the 13-bit address of the EEPROM location being accessed. These devices have 1K or 2K words of program Flash, with an address range from 0000h to 03FFh for the PIC16F818 and 0000h to 07FFh for the PIC16F819. Addresses above the range of the respective device will wraparound to the beginning of program memory.

The EEPROM data memory allows single byte read and write. The Flash program memory allows single-word reads and four-word block writes. Program memory writes must first start with a 32-word block erase, then write in 4-word blocks. A byte write in data EEPROM memory automatically erases the location and writes the new data (erase before write).

The write time is controlled by an on-chip timer. The write/erase voltages are generated by an on-chip charge pump, rated to operate over the voltage range of the device for byte or word operations.

When the device is code-protected, the CPU may continue to read and write the data EEPROM memory. Depending on the settings of the write-protect bits, the device may or may not be able to write certain blocks of the program memory; however, reads of the program memory are allowed. When code-protected, the device programmer can no longer access data or program memory; this does NOT inhibit internal reads or writes.

3.1 EEADR and EEADRH

The EEADRH:EEADR register pair can address up to a maximum of 256 bytes of data EEPROM or up to a maximum of 8K words of program EEPROM. When selecting a data address value, only the LSB of the address is written to the EEADR register. When selecting a program address value, the MSB of the address is written to the EEADRH register and the LSB is written to the EEADR register.

If the device contains less memory than the full address reach of the address register pair, the Most Significant bits of the registers are not implemented. For example, if the device has 128 bytes of data EEPROM, the Most Significant bit of EEADR is not implemented on access to data EEPROM.

3.2 EECON1 and EECON2 Registers

EECON1 is the control register for memory accesses.

Control bit, EEPGD, determines if the access will be a program or data memory access. When clear, as it is when Reset, any subsequent operations will operate on the data memory. When set, any subsequent operations will operate on the program memory.

Control bits, RD and WR, initiate read and write, respectively. These bits cannot be cleared, only set in software. They are cleared in hardware at completion of the read or write operation. The inability to clear the WR bit in software prevents the accidental, premature termination of a write operation.

The WREN bit, when set, will allow a write or erase operation. On power-up, the WREN bit is clear. The WRERR bit is set when a write (or erase) operation is interrupted by a MCLR or a WDT Time-out Reset during normal operation. In these situations, following Reset, the user can check the WRERR bit and rewrite the location. The data and address will be unchanged in the EEDATA and EEADR registers.

Interrupt flag bit, EEIF in the PIR2 register, is set when the write is complete. It must be cleared in software.

EECON2 is not a physical register. Reading EECON2 will read all '0's. The EECON2 register is used exclusively in the EEPROM write sequence.

PIC16F818/819

REGISTER 3-1: EECON1: EEPROM ACCESS CONTROL REGISTER 1 (ADDRESS 18Ch)

R/W-x	U-0	U-0	R/W-x	R/W-x	R/W-0	R/S-0	R/S-0
EEPGD	—	—	FREE	WRERR	WREN	WR	RD
bit 7							bit 0

- bit 7 **EEPGD:** Program/Data EEPROM Select bit
1 = Accesses program memory
0 = Accesses data memory
Reads '0' after a POR; this bit cannot be changed while a write operation is in progress.
- bit 6-5 **Unimplemented:** Read as '0'
- bit 4 **FREE:** EEPROM Forced Row Erase bit
1 = Erase the program memory row addressed by EEADRH:EEADR on the next WR command
0 = Perform write-only
- bit 3 **WRERR:** EEPROM Error Flag bit
1 = A write operation is prematurely terminated (any $\overline{\text{MCLR}}$ or any WDT Reset during normal operation)
0 = The write operation completed
- bit 2 **WREN:** EEPROM Write Enable bit
1 = Allows write cycles
0 = Inhibits write to the EEPROM
- bit 1 **WR:** Write Control bit
1 = Initiates a write cycle. The bit is cleared by hardware once write is complete. The WR bit can only be set (not cleared) in software.
0 = Write cycle to the EEPROM is complete
- bit 0 **RD:** Read Control bit
1 = Initiates an EEPROM read, RD is cleared in hardware. The RD bit can only be set (not cleared) in software.
0 = Does not initiate an EEPROM read

Legend:

R = Readable bit W = Writable bit S = Set only U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

PIC16F818/819

9.1 Capture Mode

In Capture mode, CCP1H:CCP1L captures the 16-bit value of the TMR1 register when an event occurs on the CCP1 pin. An event is defined as:

- Every falling edge
- Every rising edge
- Every 4th rising edge
- Every 16th rising edge

An event is selected by control bits, CCP1M3:CCP1M0 (CCP1CON<3:0>). When a capture is made, the interrupt request flag bit, CCP1IF (PIR1<2>), is set. It must be cleared in software. If another capture occurs before the value in register CCP1 is read, the old captured value is overwritten by the new captured value.

9.1.1 CCP PIN CONFIGURATION

In Capture mode, the CCP1 pin should be configured as an input by setting the TRISB<x> bit.

- Note 1:** If the CCP1 pin is configured as an output, a write to the port can cause a capture condition.
- 2:** The TRISB bit (2 or 3) is dependent upon the setting of configuration bit 12 (CCPMX).

9.1.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode for the CCP module to use the capture feature. In Asynchronous Counter mode, the capture operation may not work.

9.1.3 SOFTWARE INTERRUPT

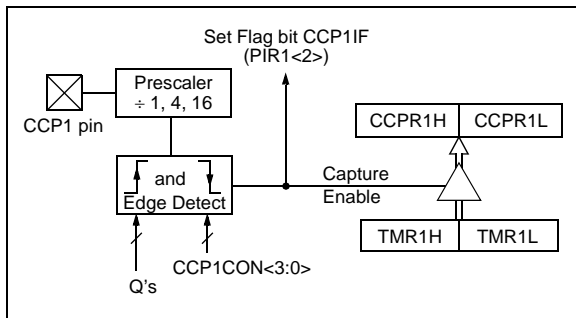
When the Capture mode is changed, a false capture interrupt may be generated. The user should keep bit, CCP1IE (PIE1<2>), clear to avoid false interrupts and should clear the flag bit, CCP1IF, following any such change in operating mode.

9.1.4 CCP PRESCALER

There are four prescaler settings specified by bits CCP1M3:CCP1M0. Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. This means that any Reset will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared; therefore, the first capture may be from a non-zero prescaler. Example 9-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the “false” interrupt.

FIGURE 9-1: CAPTURE MODE OPERATION BLOCK DIAGRAM



EXAMPLE 9-1: CHANGING BETWEEN CAPTURE PRESCALERS

```
CLRF    CCP1CON    ;Turn CCP module off
MOVLW   NEW_CAPT_PS ;Load the W reg with
                        ;the new prescaler
MOVWF   CCP1CON    ;move value and CCP ON
```

The ADRESH:ADRESL registers contain the result of the A/D conversion. When the A/D conversion is complete, the result is loaded into the A/D Result register pair, the GO/DONE bit (ADCON0<2>) is cleared and A/D Interrupt Flag bit, ADIF, is set. The block diagram of the A/D module is shown in Figure 11-1.

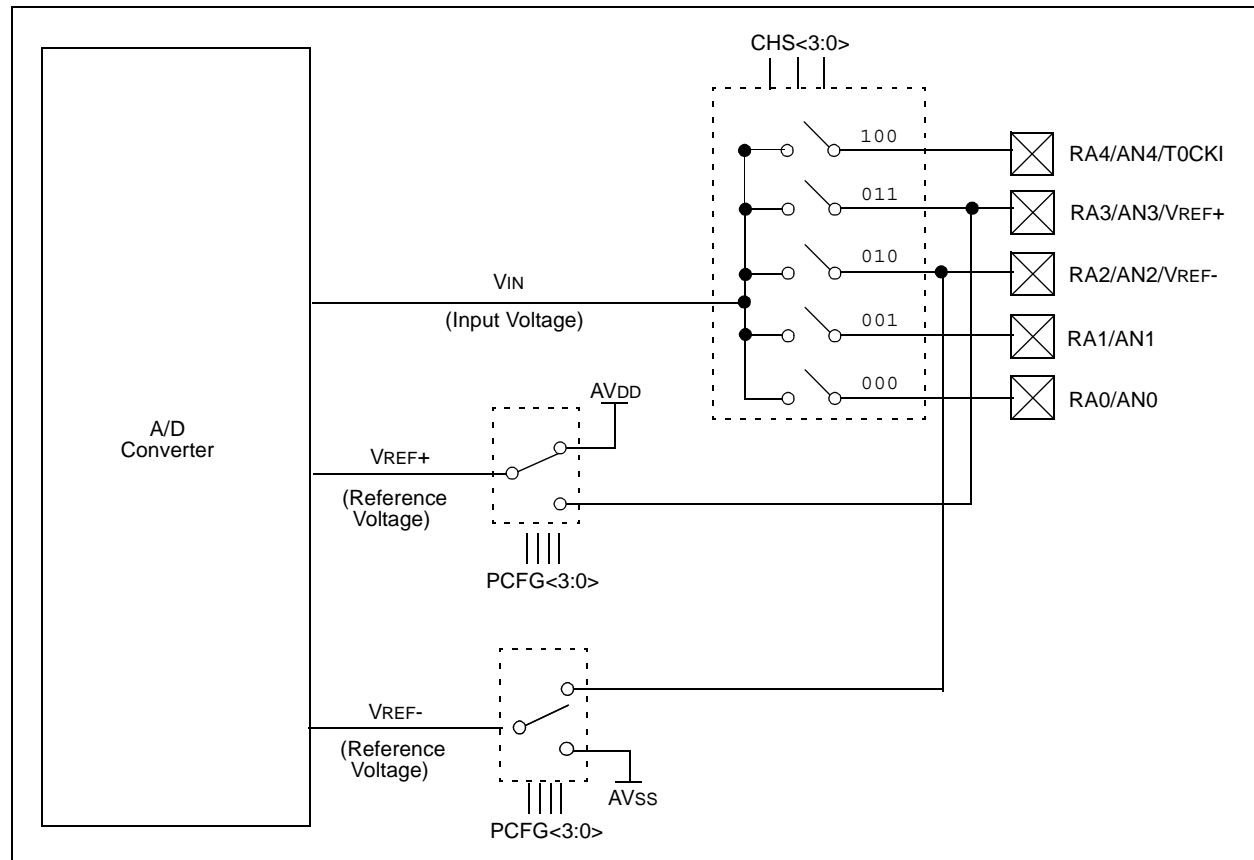
After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as inputs.

To determine sample time, see **Section 11.1 “A/D Acquisition Requirements”**. After this sample time has elapsed, the A/D conversion can be started.

These steps should be followed for doing an A/D conversion:

1. Configure the A/D module:
 - Configure analog pins/voltage reference and digital I/O (ADCON1)
 - Select A/D input channel (ADCON0)
 - Select A/D conversion clock (ADCON0)
 - Turn on A/D module (ADCON0)
2. Configure A/D interrupt (if desired):
 - Clear ADIF bit
 - Set ADIE bit
 - Set GIE bit
3. Wait the required acquisition time.
4. Start conversion:
 - Set GO/DONE bit (ADCON0)
5. Wait for A/D conversion to complete by either:
 - Polling for the GO/DONE bit to be cleared (with interrupts disabled); OR
 - Waiting for the A/D interrupt
6. Read A/D Result register pair (ADRESH:ADRESL), clear bit ADIF if required.
7. For next conversion, go to step 1 or step 2 as required. The A/D conversion time per bit is defined as TAD. A minimum wait of 2 TAD is required before the next acquisition starts.

FIGURE 11-1: A/D BLOCK DIAGRAM



11.2 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as T_{AD} . The A/D conversion requires 9.0 T_{AD} per 10-bit conversion. The source of the A/D conversion clock is software selectable. The seven possible options for T_{AD} are:

- 2 T_{OSC}
- 4 T_{OSC}
- 8 T_{OSC}
- 16 T_{OSC}
- 32 T_{OSC}
- 64 T_{OSC}
- Internal A/D module RC oscillator (2-6 μs)

For correct A/D conversions, the A/D conversion clock (T_{AD}) must be selected to ensure a minimum T_{AD} time as small as possible, but no less than 1.6 μs and not greater than 6.4 μs .

Table 11-1 shows the resultant T_{AD} times derived from the device operating frequencies and the A/D clock source selected.

11.3 Configuring Analog Port Pins

The ADCON1 and TRISA registers control the operation of the A/D port pins. The port pins that are desired as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (V_{OH} or V_{OL}) will be converted.

The A/D operation is independent of the state of the CHS<2:0> bits and the TRIS bits.

Note 1: When reading the Port register, all pins configured as analog input channels will read as cleared (a low level). Pins configured as digital inputs will convert an analog input. Analog levels on a digitally configured input will not affect the conversion accuracy.

2: Analog levels on any pin that is defined as a digital input (including the AN4:AN0 pins) may cause the input buffer to consume current out of the device specification.

TABLE 11-1: T_{AD} vs. MAXIMUM DEVICE OPERATING FREQUENCIES (STANDARD DEVICES (F))

Operation	AD Clock Source (T_{AD})		Maximum Device Frequency
	ADCS<2>	ADCS<1:0>	
2 T_{OSC}	0	00	1.25 MHz
4 T_{OSC}	1	00	2.5 MHz
8 T_{OSC}	0	01	5 MHz
16 T_{OSC}	1	01	10 MHz
32 T_{OSC}	0	10	20 MHz
64 T_{OSC}	1	10	20 MHz
RC ^(1,2,3)	X	11	(Note 1)

Note 1: The RC source has a typical T_{AD} time of 4 μs but can vary between 2-6 μs .

2: When the device frequencies are greater than 1 MHz, the RC A/D conversion clock source is only recommended for Sleep operation.

3: For extended voltage devices (LF), please refer to **Section 15.0 “Electrical Characteristics”**.

12.2 Reset

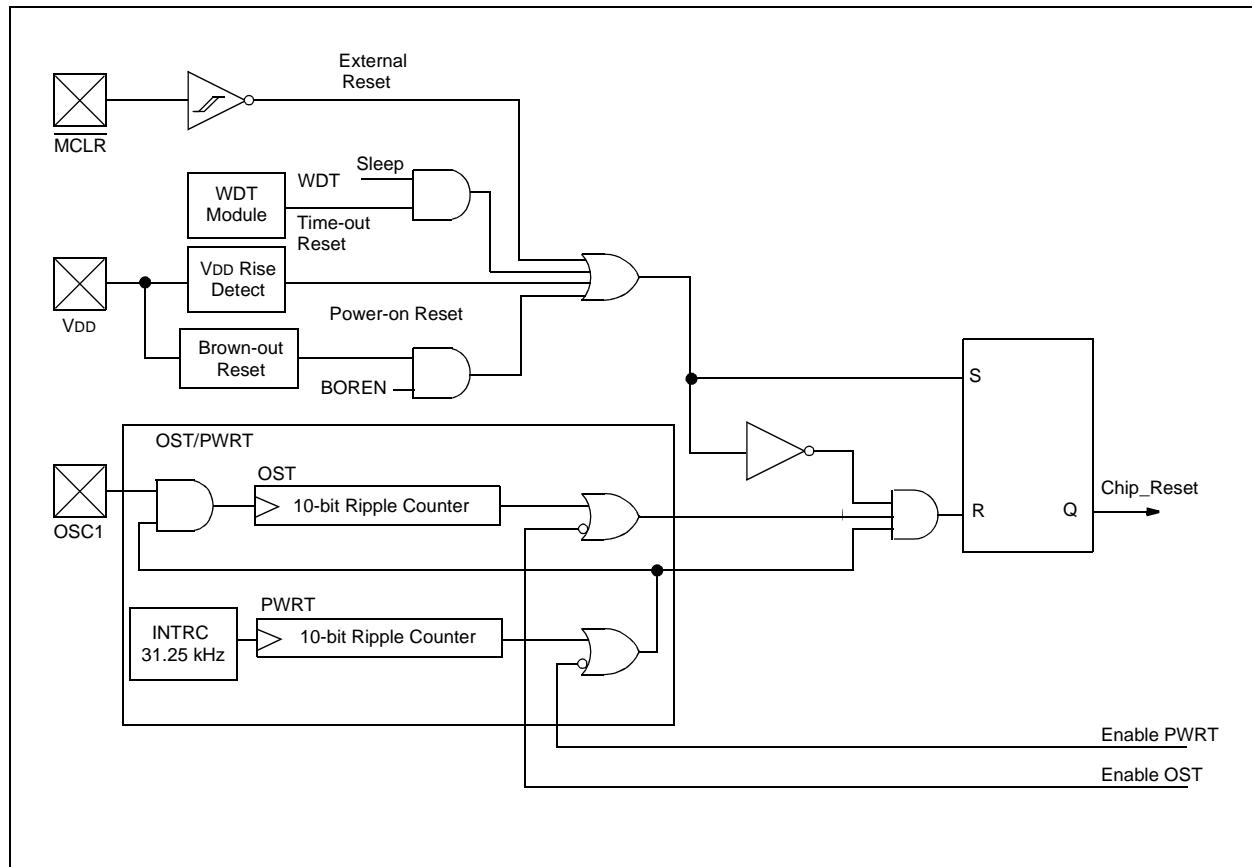
The PIC16F818/819 differentiates between various kinds of Reset:

- Power-on Reset (POR)
- $\overline{\text{MCLR}}$ Reset during normal operation
- $\overline{\text{MCLR}}$ Reset during Sleep
- WDT Reset during normal operation
- WDT wake-up during Sleep
- Brown-out Reset (BOR)

Some registers are not affected in any Reset condition. Their status is unknown on POR and unchanged in any other Reset. Most other registers are reset to a "Reset state" on Power-on Reset (POR), on the $\overline{\text{MCLR}}$ and WDT Reset, on $\overline{\text{MCLR}}$ Reset during Sleep and Brown-out Reset (BOR). They are not affected by a WDT wake-up which is viewed as the resumption of normal operation. The $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits are set or cleared differently in different Reset situations as indicated in Table 12-3. These bits are used in software to determine the nature of the Reset. Upon a POR, BOR or wake-up from Sleep, the CPU requires approximately 5-10 μs to become ready for code execution. This delay runs in parallel with any other timers. See Table 12-4 for a full description of Reset states of all registers.

A simplified block diagram of the on-chip Reset circuit is shown in Figure 12-1.

FIGURE 12-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



14.11 PICkit 2 Development Programmer/Debugger and PICkit 2 Debug Express

The PICkit™ 2 Development Programmer/Debugger is a low-cost development tool with an easy to use interface for programming and debugging Microchip's Flash families of microcontrollers. The full featured Windows® programming interface supports baseline (PIC10F, PIC12F5xx, PIC16F5xx), midrange (PIC12F6xx, PIC16F), PIC18F, PIC24, dsPIC30, dsPIC33, and PIC32 families of 8-bit, 16-bit, and 32-bit microcontrollers, and many Microchip Serial EEPROM products. With Microchip's powerful MPLAB Integrated Development Environment (IDE) the PICkit™ 2 enables in-circuit debugging on most PIC® microcontrollers. In-Circuit-Debugging runs, halts and single steps the program while the PIC microcontroller is embedded in the application. When halted at a breakpoint, the file registers can be examined and modified.

The PICkit 2 Debug Express include the PICkit 2, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

14.12 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages and a modular, detachable socket assembly to support various package types. The ICSP™ cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices and incorporates an MMC card for file storage and data applications.

14.13 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ® security ICs, CAN, IrDA®, PowerSmart battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

PIC16F818/819

15.2 DC Characteristics: Power-Down and Supply Current PIC16F818/819 (Industrial, Extended) PIC16LF818/819 (Industrial)

PIC16LF818/819 (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial				
PIC16F818/819 (Industrial, Extended)		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended				
Param No.	Device	Typ	Max	Units	Conditions	
	Power-Down Current (IPD)⁽¹⁾					
	PIC16LF818/819	0.1	0.4	μA	-40°C	VDD = 2.0V
		0.1	0.4	μA	+25°C	
		0.4	1.5	μA	+85°C	
	PIC16LF818/819	0.3	0.5	μA	-40°C	VDD = 3.0V
		0.3	0.5	μA	+25°C	
		0.7	1.7	μA	+85°C	
	All devices	0.6	1.0	μA	-40°C	VDD = 5.0V
		0.6	1.0	μA	+25°C	
		1.2	5.0	μA	+85°C	
	Extended devices	6.0	28	μA	+125°C	

Legend: Shading of rows is to assist in readability of the table.

- Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to V_{DD} or V_{SS} and all features that add delta current disabled (such as WDT, Timer1 Oscillator, BOR, etc.).
- 2:** The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.
The test conditions for all I_{PD} measurements in active operation mode are:
OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to V_{DD} ;
MCLR = V_{DD} ; WDT enabled/disabled as specified.
- 3:** For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula $I_r = V_{DD}/2R_{EXT}$ (mA) with REXT in k Ω .

15.2 DC Characteristics: Power-Down and Supply Current

PIC16F818/819 (Industrial, Extended)

PIC16LF818/819 (Industrial) (Continued)

PIC16LF818/819 (Industrial)		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial					
PIC16F818/819 (Industrial, Extended)		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended					
Param No.	Device	Typ	Max	Units	Conditions		
	Supply Current (I_{DD})^(2,3)						
	All devices	1.8	2.3	mA	-40°C	$V_{DD} = 4.0\text{V}$	Fosc = 20 MHz (HS Oscillator)
		1.6	2.2	mA	$+25^{\circ}\text{C}$		
		1.3	2.2	mA	$+85^{\circ}\text{C}$		
	All devices	3.0	4.2	mA	-40°C	$V_{DD} = 5.0\text{V}$	
		2.5	4.0	mA	$+25^{\circ}\text{C}$		
		2.5	4.0	mA	$+85^{\circ}\text{C}$		
	Extended devices	3.0	5.0	mA	$+125^{\circ}\text{C}$		

Legend: Shading of rows is to assist in readability of the table.

- Note 1:** The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to V_{DD} or V_{SS} and all features that add delta current disabled (such as WDT, Timer1 Oscillator, BOR, etc.).
- 2:** The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.
The test conditions for all I_{DD} measurements in active operation mode are:
 $\overline{\text{OSC1}}$ = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to V_{DD} ;
 $\overline{\text{MCLR}}$ = V_{DD} ; WDT enabled/disabled as specified.
- 3:** For RC oscillator configurations, current through R_{EXT} is not included. The current through the resistor can be estimated by the formula $I_r = V_{DD}/2R_{EXT}$ (mA) with R_{EXT} in $k\Omega$.

FIGURE 15-9: CAPTURE/COMPARE/PWM TIMINGS (CCP1)

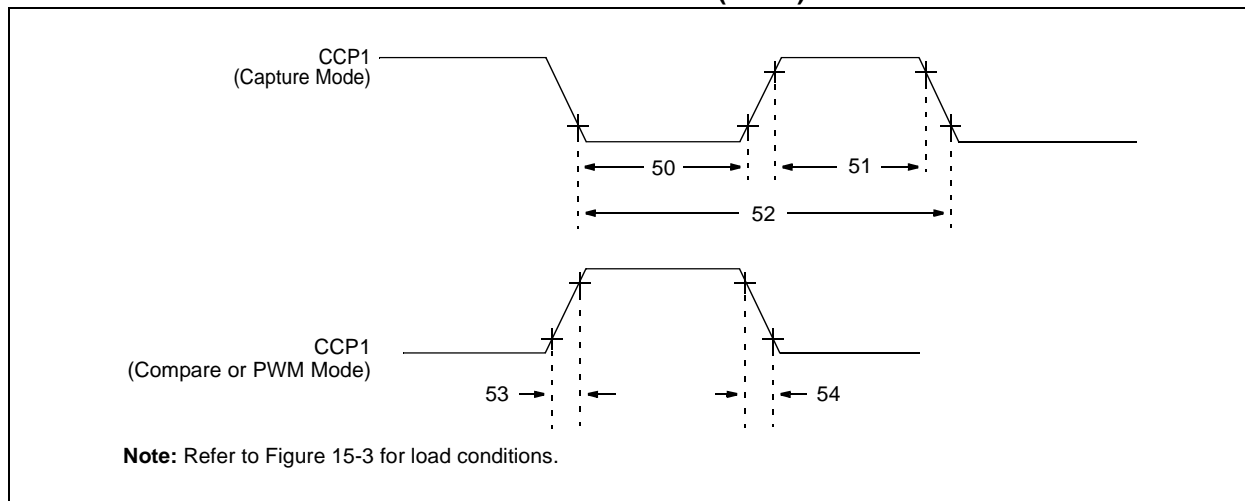


TABLE 15-5: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1)

Param No.	Symbol	Characteristic		Min	Typ†	Max	Units	Conditions	
50*	TccL	CCP1 Input Low Time	No Prescaler		0.5 Tcy + 20	—	—	ns	
			With Prescaler	PIC16F818/819	10	—	—	ns	
				PIC16LF818/819	20	—	—	ns	
51*	TccH	CCP1 Input High Time	No Prescaler		0.5 Tcy + 20	—	—	ns	
			With Prescaler	PIC16F818/819	10	—	—	ns	
				PIC16LF818/819	20	—	—	ns	
52*	TccP	CCP1 Input Period			$\frac{3 T_{CY} + 40}{N}$	—	—	ns	N = prescale value (1,4 or 16)
53*	TccR	CCP1 Output Rise Time		PIC16F818/819	—	10	25	ns	
				PIC16LF818/819	—	25	50	ns	
54*	TccF	CCP1 Output Fall Time		PIC16F818/819	—	10	25	ns	
				PIC16LF818/819	—	25	45	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16F818/819

FIGURE 16-3: TYPICAL I_{DD} vs. F_{osc} OVER V_{DD} (XT MODE)

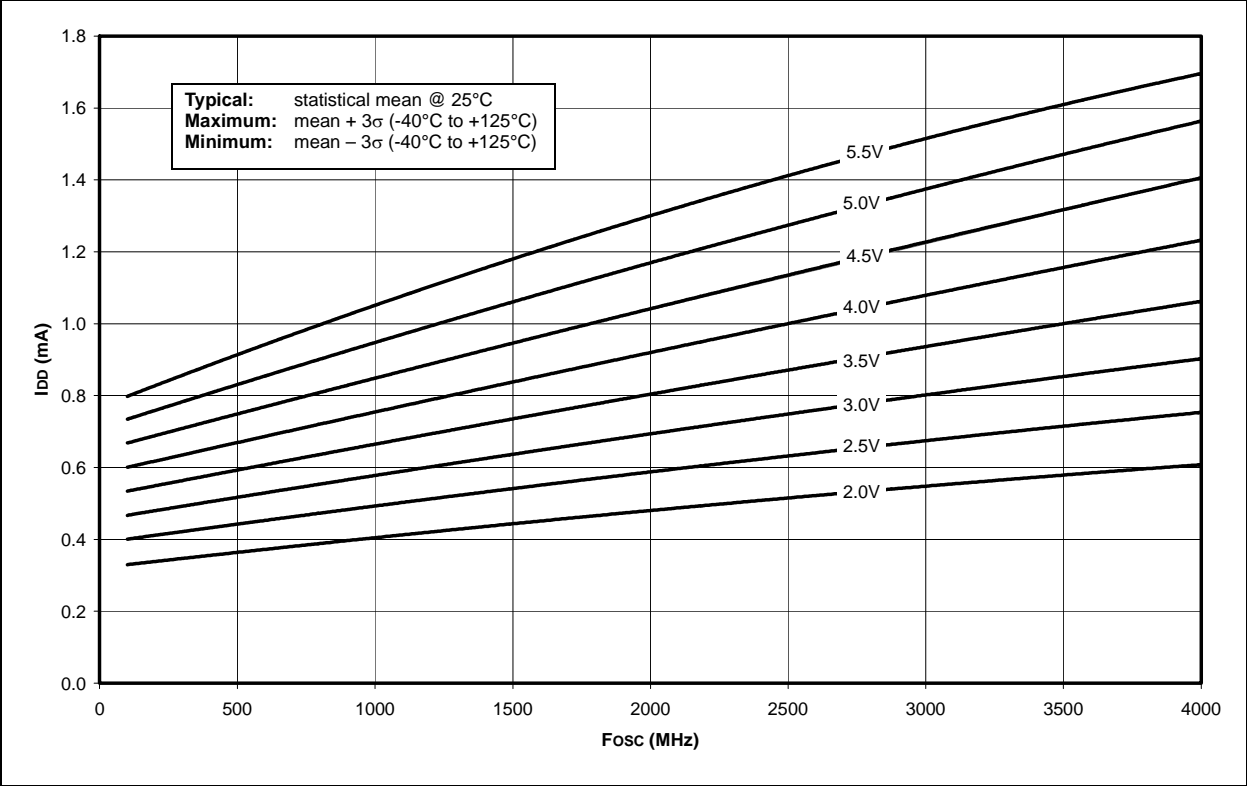


FIGURE 16-4: MAXIMUM I_{DD} vs. F_{osc} OVER V_{DD} (XT MODE)

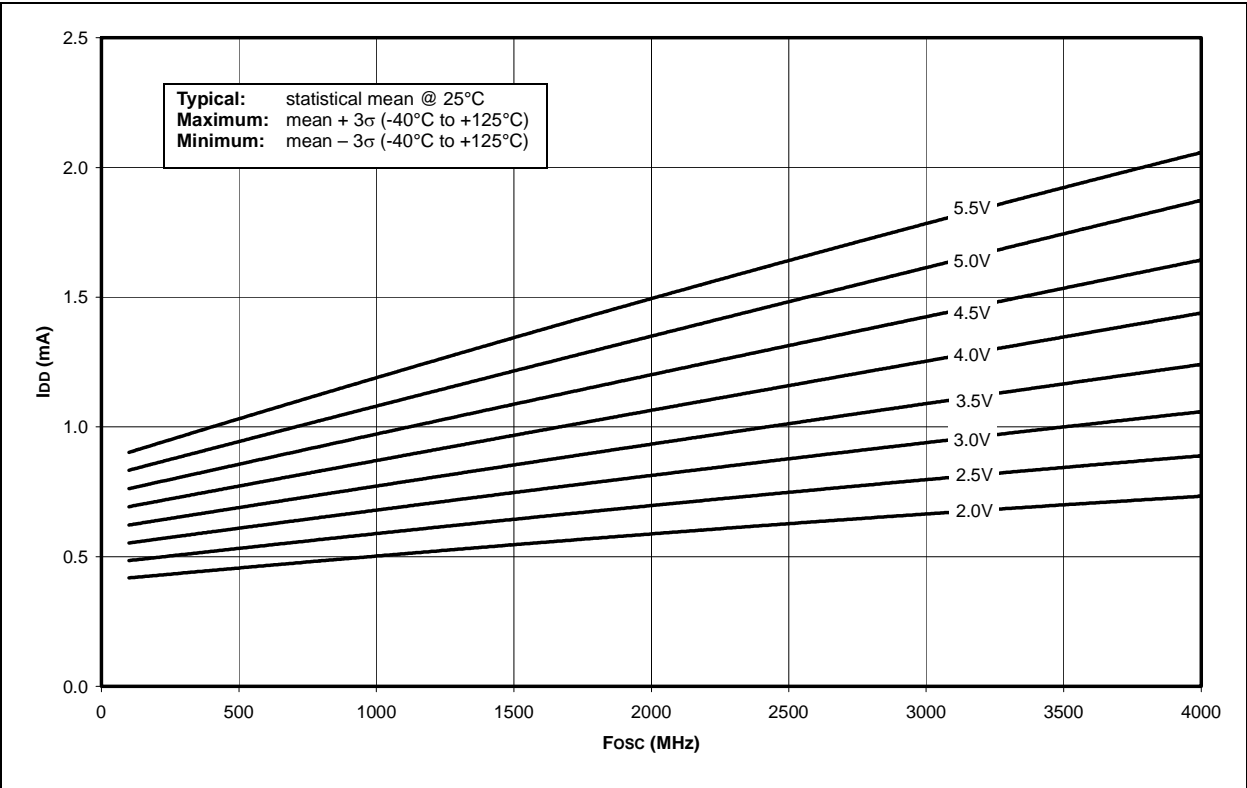


FIGURE 16-9: I_{PD} vs. V_{DD}, -40°C TO +125°C (SLEEP MODE, ALL PERIPHERALS DISABLED)

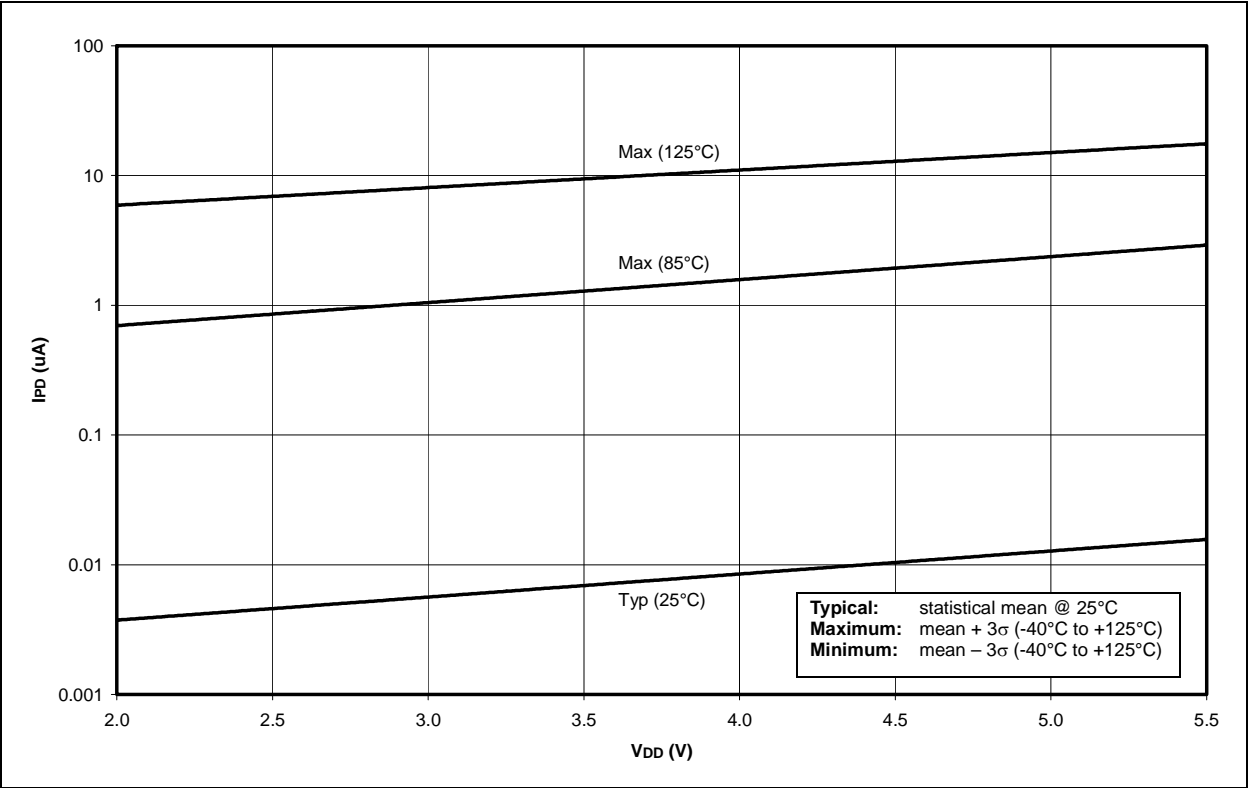


FIGURE 16-10: AVERAGE F_{OSC} vs. V_{DD} FOR VARIOUS VALUES OF R (RC MODE, C = 20 pF, +25°C)

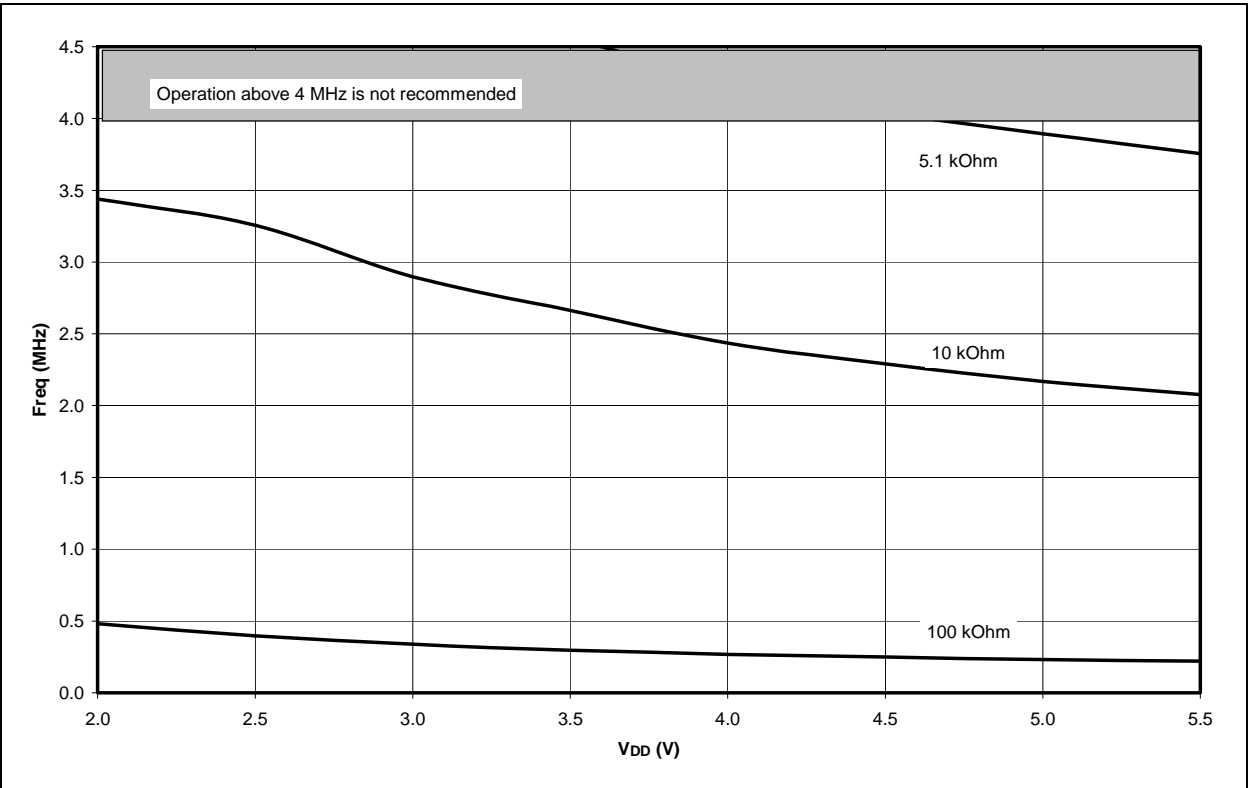


FIGURE 16-21: MINIMUM AND MAXIMUM V_{IN} vs. V_{DD} (TTL INPUT, -40°C TO +125°C)

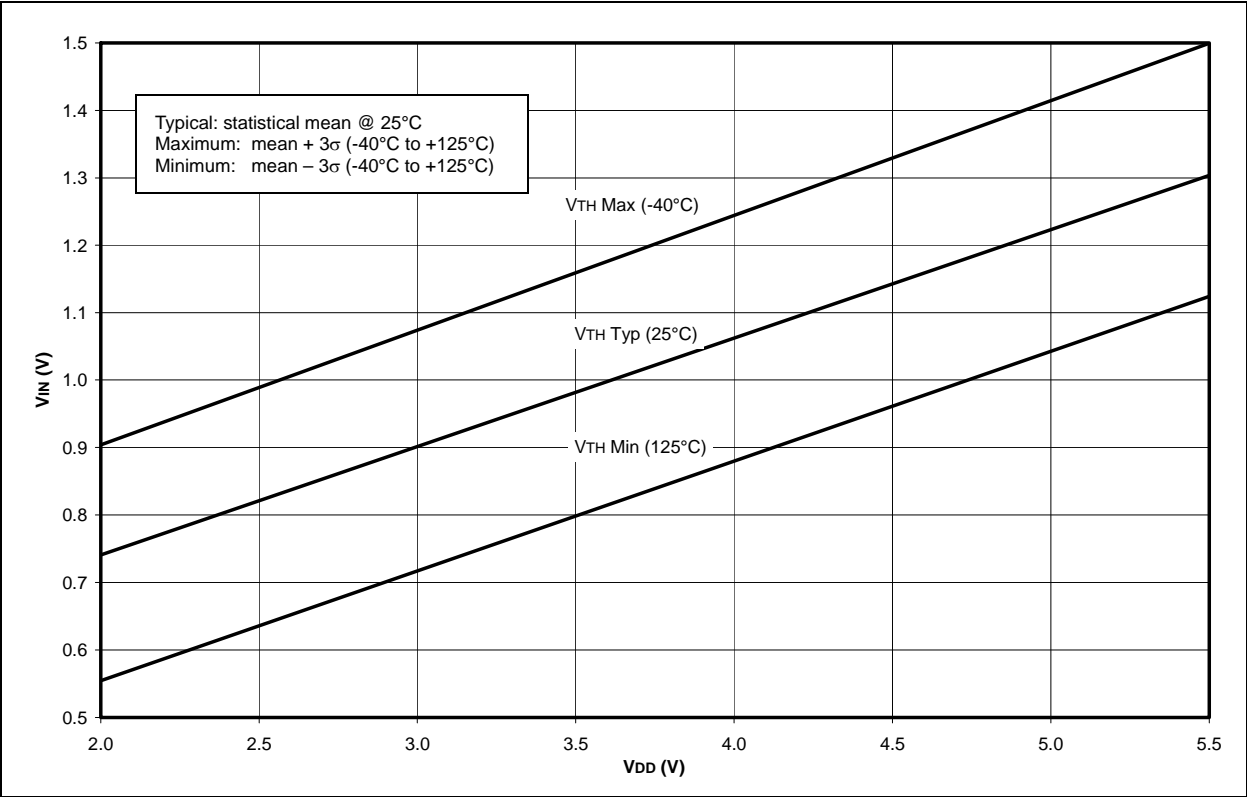
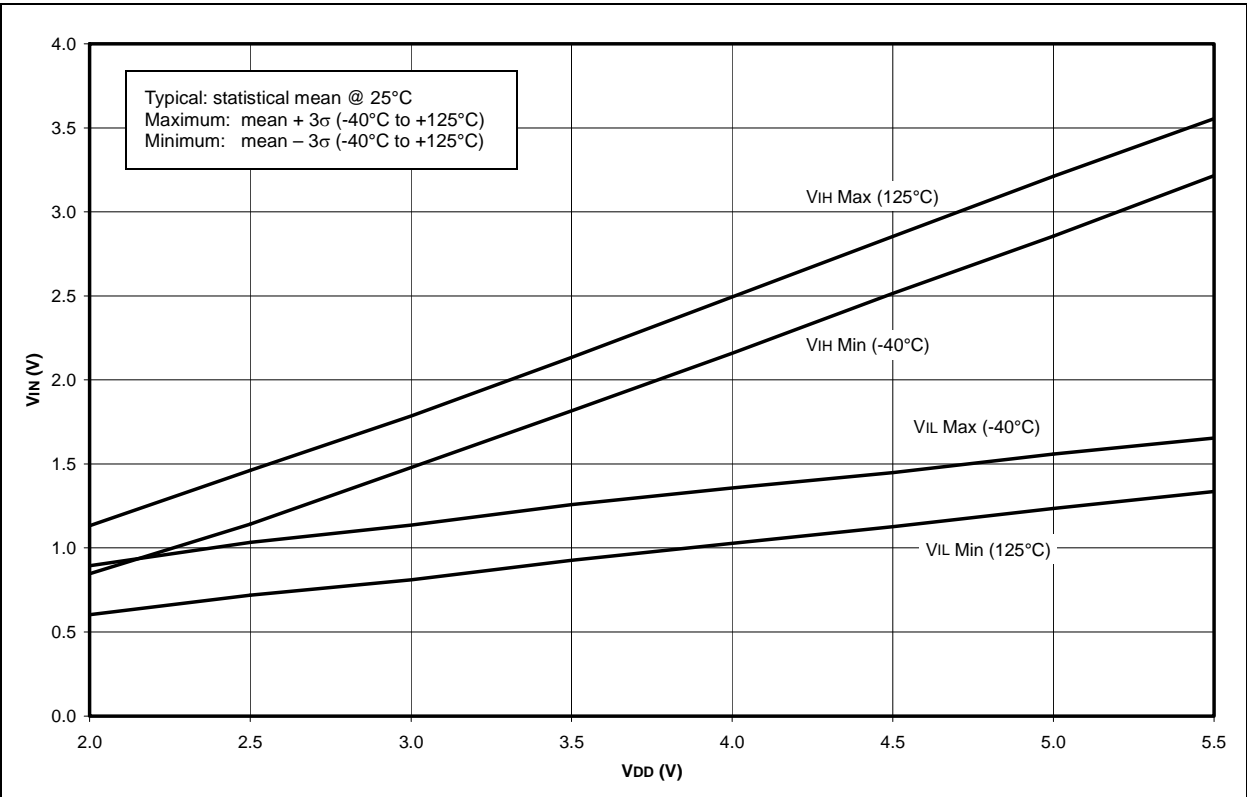
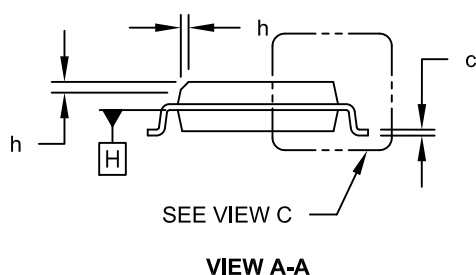
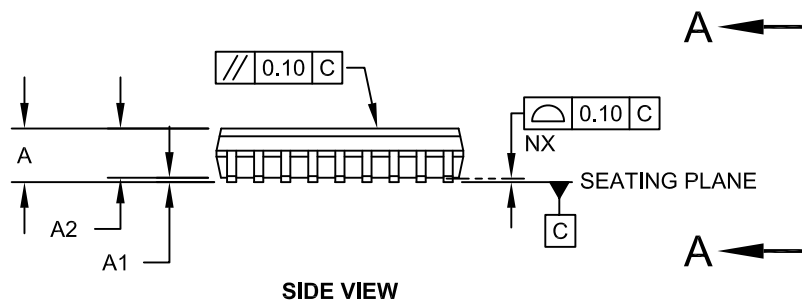


FIGURE 16-22: MINIMUM AND MAXIMUM V_{IN} vs. V_{DD} (ST INPUT, -40°C TO +125°C)



[illegible]

PIC16F818/819

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (May 2002)

Original version of this data sheet.

Revision B (August 2002)

Added INTRC section. PWRT and BOR are independent of each other. Revised program memory text and code routine. Added QFN package. Modified PORTB diagrams.

Revision C (November 2002)

Added various new feature descriptions. Added internal RC oscillator specifications. Added low-power Timer1 specifications and RTC application example.

Revision D (November 2003)

Updated IRCF bit modification information and changed the INTOSC stabilization delay from 1 ms to 4 ms in **Section 4.0 “Oscillator Configurations”**. Updated **Section 12.17 “In-Circuit Serial Programming”** to clarify LVP programming. In **Section 15.0 “Electrical Characteristics”**, the DC Characteristics (**Section 15.2** and **Section 15.3**) have been updated to include the Typ, Min and Max values and Table 15-1 “**External Clock Timing Requirements**” has been updated.

Revision E (September 2004)

This revision includes the DC and AC Characteristics Graphs and Tables. The Electrical Specifications in **Section 16.0 “DC and AC Characteristics Graphs and Tables”** have been updated and there have been minor corrections to the data sheet text.

Revision F (November 2011)

This revision updated **Section 17.0 “Packaging Information”**.

APPENDIX B: DEVICE DIFFERENCES

The differences between the devices in this data sheet are listed in Table B-1.

TABLE B-1: DIFFERENCES BETWEEN THE PIC16F818 AND PIC16F819

Features	PIC16F818	PIC16F819
Flash Program Memory (14-bit words)	1K	2K
Data Memory (bytes)	128	256
EEPROM Data Memory (bytes)	128	256

PIC16F818/819

Program Memory	
Interrupt Vector	9
Map and Stack	
PIC16F818	9
PIC16F819	9
Reset Vector	9
Program Verification	100
PUSH	23
R	
R/W Bit	77
RA0/AN0 Pin	7
RA1/AN1 Pin	7
RA2/AN2/Vref- Pin	7
RA3/AN3/Vref+ Pin	7
RA4/AN4/T0CKI Pin	7
RA5/(MCLR/Vpp Pin	7
RA6/OSC2/CLKO Pin	7
RA7/OSC1/CLKI Pin	7
RB0/INT Pin	8
RB1/SDI/SDA Pin	8
RB2/SDO/CCP1 Pin	8
RB3/CCP1/PGM Pin	8
RB4/SCK/SCL Pin	8
RB5/ \overline{SS} Pin	8
RB6/T1OSO/T1CKI/PGC Pin	8
RB7/T1OSI/PGD Pin	8
RBIF Bit	43
RCIO Oscillator Mode	35
Reader Response	174
Receive Overflow Indicator Bit, SSPOV	73
Register File Map	
PIC16F818	11
PIC16F819	12
Registers	
ADCON0 (A/D Control 0)	81
ADCON1 (A/D Control 1)	82
CCP1CON (Capture/Compare/PWM Control 1)	65
Configuration Word	90
EECON1 (Data EEPROM Access Control 1)	26
Initialization Conditions (table)	94
INTCON (Interrupt Control)	18
OPTION_REG (Option)	17, 54
OSCCON (Oscillator Control)	38
OSCTUNE (Oscillator Tuning)	36
PCON (Power Control)	22
PIE1 (Peripheral Interrupt Enable 1)	19
PIE2 (Peripheral Interrupt Enable 2)	21
PIR1 (Peripheral Interrupt Request (Flag) 1)	20
PIR2 (Peripheral Interrupt Request (Flag) 2)	21
SSPCON (Synchronous Serial Port Control 1)	73
SSPSTAT (Synchronous Serial Port Status)	72
Status	16
T1CON (Timer1 Control)	57
T2CON (Timer2 Control)	64
Reset	89, 91
Brown-out Reset (BOR). See Brown-out Reset (BOR).	
MCLR Reset. See MCLR.	
Power-on Reset (POR). See Power-on Reset (POR).	
Reset Conditions for All Registers	94
Reset Conditions for PCON Register	93
Reset Conditions for Program Counter	93
Reset Conditions for Status Register	93
WDT Reset. See Watchdog Timer (WDT).	

Revision History	165
RP0 Bit	10
RP1 Bit	10

S

Sales and Support	175
SCL Clock	77
Sleep	89, 91, 99
Software Simulator (MPLAB SIM)	113
Special Event Trigger	87
Special Features of the CPU	89
Special Function Register Summary	13
Special Function Registers	13
SPI Mode	
Associated Registers	74
Serial Clock	71
Serial Data In	71
Serial Data Out	71
Slave Select	71

SSP

ACK	77
I ² C	
I ² C Operation	76
SSPADDD Register	14
SSPIF	20
SSPOV	73
SSPOV Bit	77
SSPSTAT Register	14
Stack	23
Overflow	23
Underflow	23
Status Register	13, 15
DC Bit	16
IRP Bit	16
PD Bit	91
TO Bit	16, 91
Z Bit	16
Synchronous Serial Port (SSP)	71
Overview	71
SPI Mode	71
Synchronous Serial Port Interrupt	20

T

T1CKPS0 Bit	57
T1CKPS1 Bit	57
T1OSCEN Bit	57
T1SYNC Bit	57
T2CKPS0 Bit	64
T2CKPS1 Bit	64
Tad	85
Time-out Sequence	92
Timer0	53
Associated Registers	55
Clock Source Edge Select (T0SE Bit)	17
Clock Source Select (T0CS Bit)	17
External Clock	54
Interrupt	53
Operation	53
Overflow Enable (TMR0IE Bit)	18
Overflow Flag (TMR0IF Bit)	97
Overflow Interrupt	97
Prescaler	54
T0CKI	54